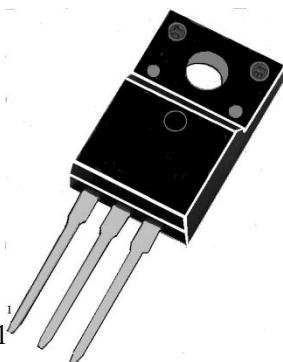


### ◆ Features:

- ◆ Fast switching speed  
开关速度快
- ◆ High input impedance and low level drive  
高输入阻抗和低电平驱动
- ◆ Avalanche energy tested  
雪崩能量测试
- ◆ Improved dv/dt capability, high ruggedness  
提高 dv/dt 能力，高耐用性

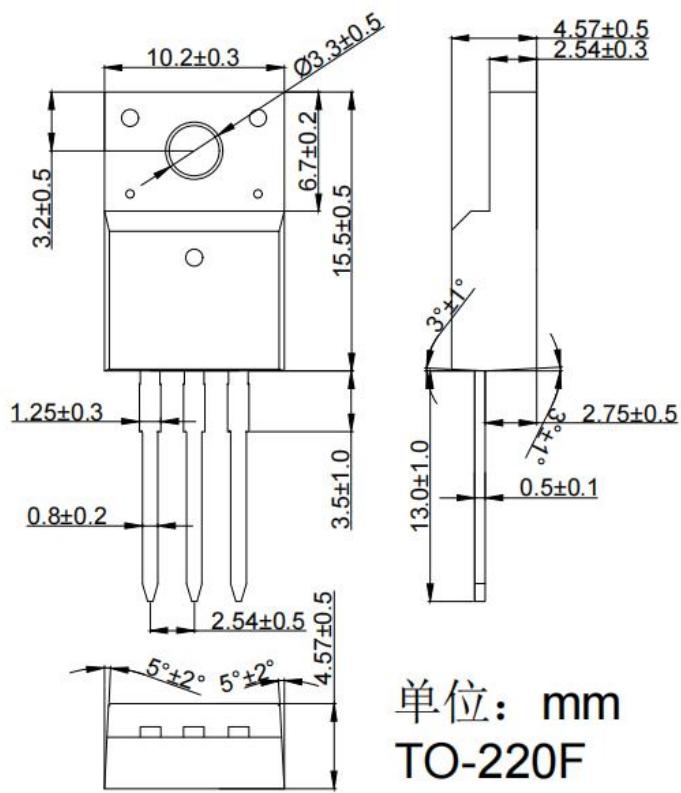
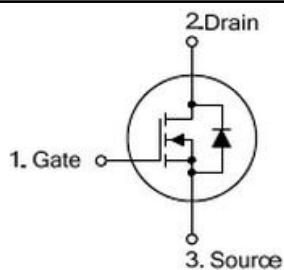
 ROHS COMPLIANT

**TO-220F**



### ◆ Applications

- ◆ High efficiency switch mode power supplies  
高效率开关电源
- ◆ Power factor correction  
功率因数校正
- ◆ Electronic lamp ballast  
电子整流器





**OSPF5N50**  
**500V N-CHANNEL MOSFET**

<http://www.osen.net.cn>

**◆ Absolute Maximum Ratings (Tc=25°C)**

Symbol	Parameters	Ratings	Unit
V <sub>DSS</sub>	Drain-Source Voltage 漏源电压	500	V
V <sub>GS</sub>	Gate-Source Voltage-Continuous 栅源电压	±30	V
I <sub>D</sub>	Drain Current-Continuous (Note 2) 漏极持续电流	5	A
I <sub>DM</sub>	Drain Current-Single Plused (Note 1) 漏极单次脉冲电流	20	A
P <sub>D</sub>	Power Dissipation (Note 2) 功率损耗	42	W
T <sub>j</sub>	Max.Operating junction temperature 最大结温	150	°C

**◆ Electrical characteristics (Tc=25°C unless otherwise noted)**

Symbol	Parameters	Min	Typ	Max	Units	Conditions
<b>Static Characteristics</b>						
B <sub>VDSS</sub>	Drain-Source Breakdown VoltageCurrent (Note 1) 漏极击穿电压	500	--	--	V	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C
V <sub>GS(th)</sub>	Gate Threshold Voltage 栅极开启电压	2.0	--	4.0	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA
R <sub>DS(on)</sub>	Drain-Source On-Resistance 漏源导通电阻	--	1.4	--	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =1A
I <sub>GSS</sub>	Gate-Body Leakage Current 栅极漏电流	--	--	±100	nA	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0
I <sub>DSS</sub>	Zero Gate Voltage Drain Current 零栅极电压漏极电流	--	--	1	μA	V <sub>DS</sub> =500V, V <sub>GS</sub> =0
<b>Switching Characteristics</b>						



OSPF5N50

500V N-CHANNEL MOSFET

T <sub>d(on)</sub>	Turn-On Delay Time 开启延迟时间	--	<b>45</b>	--	ns	V <sub>DS</sub> =250V, I <sub>D</sub> =5A, R <sub>G</sub> =25Ω (Note 2)
T <sub>r</sub>	Rise Time 上升时间	--	<b>25</b>	--	ns	
T <sub>d(off)</sub>	Turn-Off Delay Time 关闭延迟时间	--	<b>130</b>	--	ns	
T <sub>f</sub>	Fall Time 下降时间	--	<b>215</b>	--	ns	
Q <sub>g</sub>	Total Gate Charge 栅极总电荷	--	<b>13</b>	<b>20</b>	nC	V <sub>DS</sub> =400V, V <sub>GS</sub> =10V I <sub>D</sub> =5A (Note 2)
Q <sub>gs</sub>	Gate-Source Charge 栅源极电荷	--	<b>4.0</b>	--	nC	
Q <sub>gd</sub>	Gate-Drain Charge 栅漏极电荷	--	<b>7</b>	--	nC	
<b>Dynamic Characteristics</b>						

C <sub>iss</sub>	Input Capacitance 输入电容	--	<b>430</b>	--	pF	V <sub>DS</sub> =25V, V <sub>GS</sub> =0, f=1MHz
C <sub>oss</sub>	Output Capacitance 输出电容	--	<b>60</b>	--	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance 反向传输电容	--	<b>9.5</b>	--	pF	
I <sub>S</sub>	Continuous Drain-Source Diode Forward Current (Note 2) 二极管导通正向持续电流	--	--	<b>5</b>	A	
V <sub>SD</sub>	Diode Forward On-Voltage 二极管正向导通电压	--	--	<b>0.9</b>	V	I <sub>S</sub> =1A, V <sub>GS</sub> =0
R <sub>th(j-c)</sub>	Thermal Resistance, Junction to Case 结到外壳的热阻	--	--	<b>2.97</b>	°C/W	

Note 1: Repetitive Rating : Pulse width limited by maximum junction temperature

Note 2: Pulse test: PW <= 300us , duty cycle <= 2%.